

Date Sheet

Customer:

Part No: CL-SFC506IRRUV-850,630,400-02

Sample No: _____

Description: _____

Item No: _____

Customer			
Check	Inspection	Approval	Date

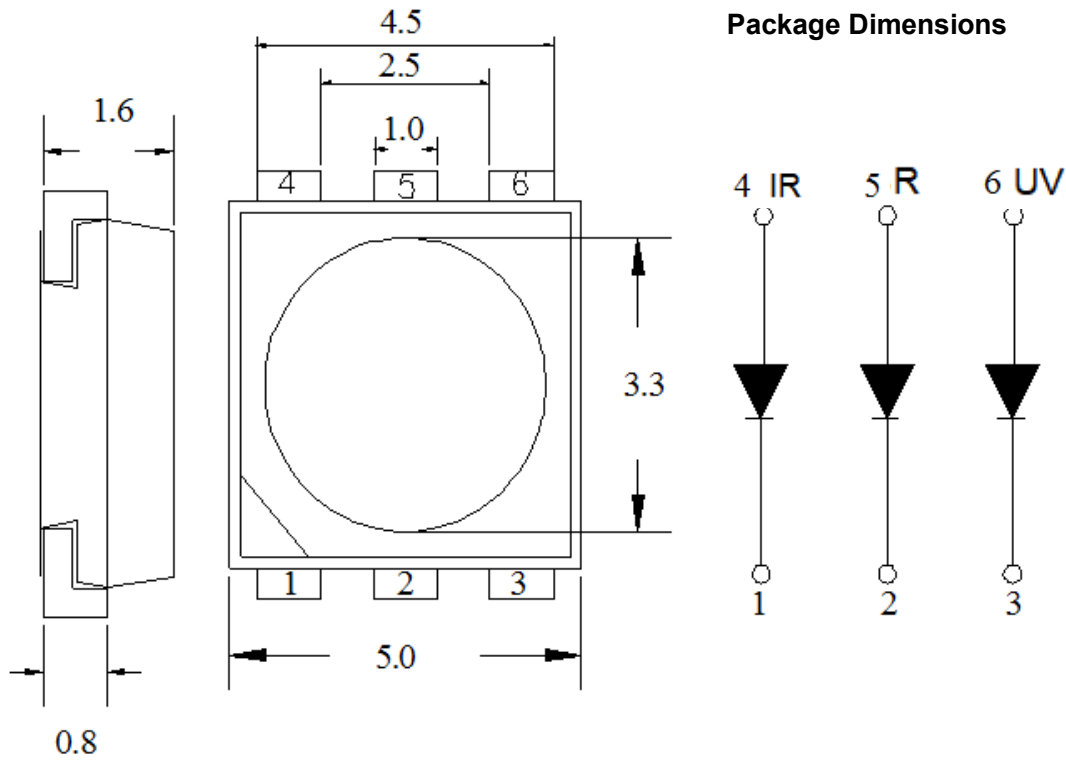
Features

- PLCC-2 Package.
- Extremely wide viewing angle.
- Suitable for all SMT assembly and solder process.
- Available on tape and reel.



Applications

- Optical indicator
- Indoor display
- Automotive lighting
- Backlight for LCD, switch and Symbol, display



Notes:

1. All dimension units are millimeters.
2. All dimension tolerance is $\pm 0.15\text{mm}$ unless otherwise noted.

Selection Guide

Part No.	Dice	LENS TYPE	Luminous intensity(mcd) @20mA		Angle
			Min	Typ	2 θ 1/2
CL-SFC506I RRUV -850, 630, 400-02	IR	Water Clear	--	8	120°
	RED		---	700	
	UV		---	180	

Note

1. 2 θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. The above luminous intensity measurement allowance tolerance is $\pm 10\%$.

Electrical / Optical Characteristics at Ta=25°C

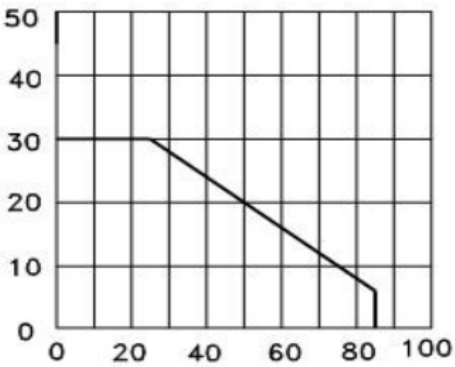
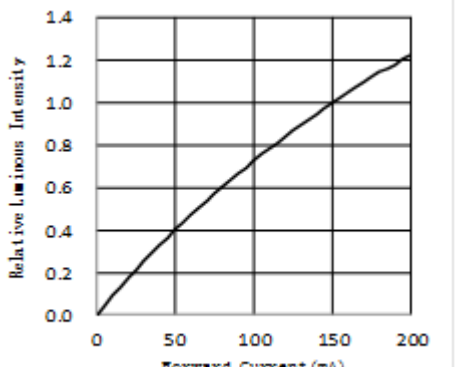
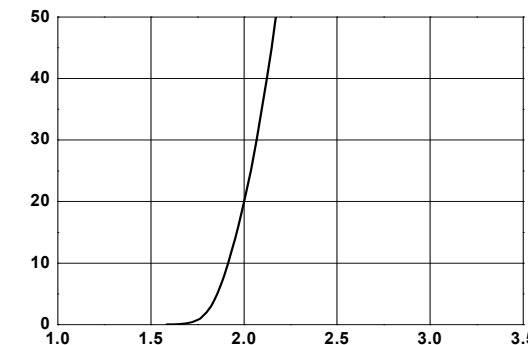
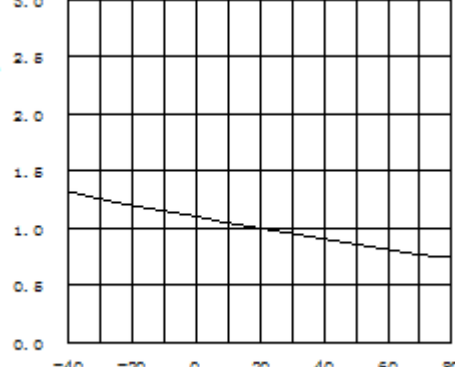
Parameter	Symbol		Min.	T _{vn}	Max.	Units	Test Conditions
Forward Voltage	VF	IR	1.2	---	1.8	V	IF=20mA
		R	1.8	----	2.4		
		UV	3.0	---	3.6		
Reverse Current	IR	----	---	---	5	uA	VR = 5V
Dominate Wavelength	λd	IR	---	850	---	nm	IF=20mA
		R	620	---	630		
		UV	395	---	400		

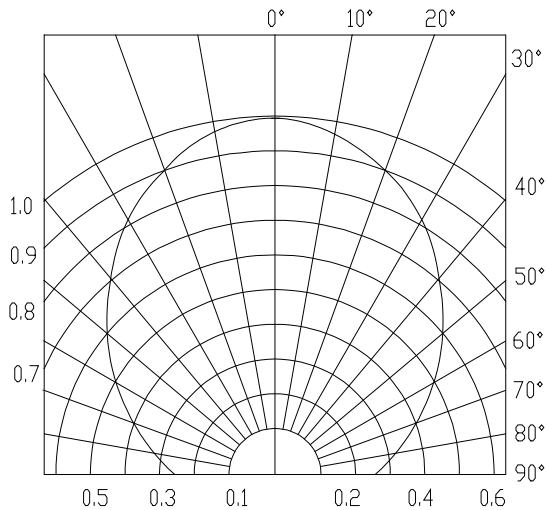
Absolute Maximum Ratings at Ta=25°C (IR/R/UV)

Parameter	Symbol	Rating	Units
Power Dissipation	Pd	72/100/100	mW
Forward Current	IF	30	mA
Peak Forward Current [1]	IFP	100	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	8000	V
Operating Temperature	Topr	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +100	°C

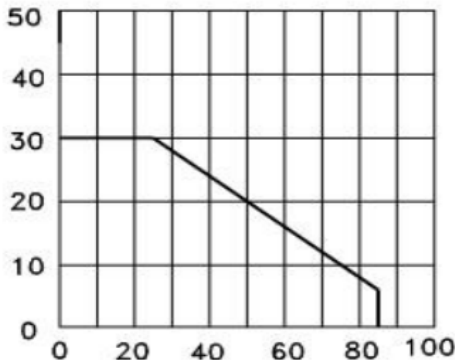
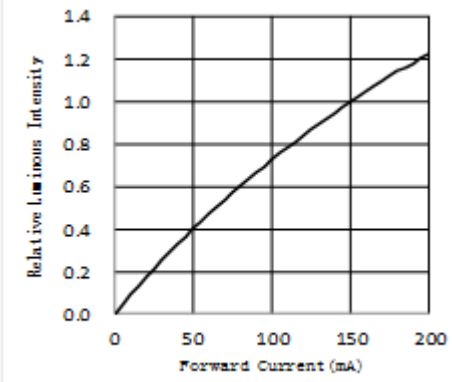
Typical optical characteristics curves (IR)

Ambient Temperature vs. Forward Current	Forward Current VS. Relative Intensity
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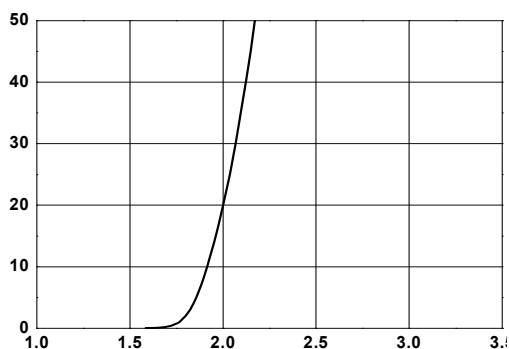
<div data-bbox="114 250 205 801">Forward Current(mA)</div> <div data-bbox="205 250 812 732">  </div> <div data-bbox="205 732 812 801">Soldering Temperature °C</div>	<div data-bbox="812 250 884 801">Relative luminous Intensity</div> <div data-bbox="884 250 1498 732">  </div> <div data-bbox="884 732 1498 801">Forward Current(mA)</div>
Forward Voltage VS. Forward Current	Ambient Temperature VS. Relative Intensity
<div data-bbox="114 936 205 1485">Forward Current(mA)</div> <div data-bbox="205 936 812 1417">  </div> <div data-bbox="205 1417 812 1485">Forward Voltage(V)</div>	<div data-bbox="812 936 884 1485">Relative luminous Intensity</div> <div data-bbox="884 936 1498 1417">  </div> <div data-bbox="884 1417 1498 1485">Ambient Temperature ta °C</div>
Relative spectral emission	Radiation diagram

Relative luminous intensity			
	Wavelength(nm)		SPATIA DISTRIBUTON

Typical optical characteristics curves (R)

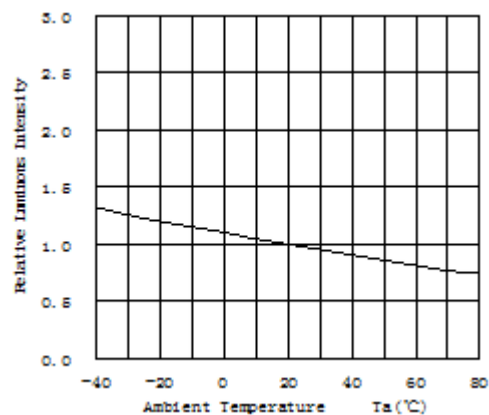
Ambient Temperature vs. Forward Current		Forward Current VS. Relative Intensity	
Forward Current(mA)		Relative luminous Intensity	
	Soldering Temperrature °C		Forward Current(mA)
Forward Voltage VS. Forward Current		Ambient Temperature VS. Relative Intensity	

Forward Current(mA)



Forward Voltage(V)

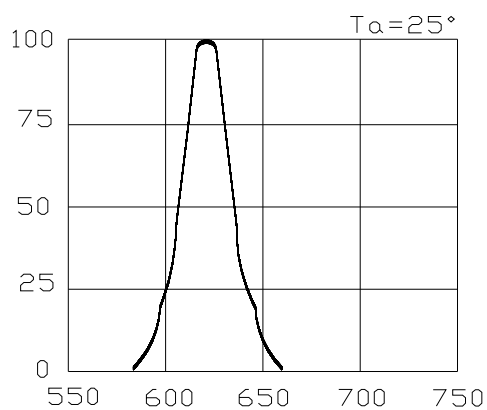
Relative luminous Intensity


Ambient Temperature T_a °C

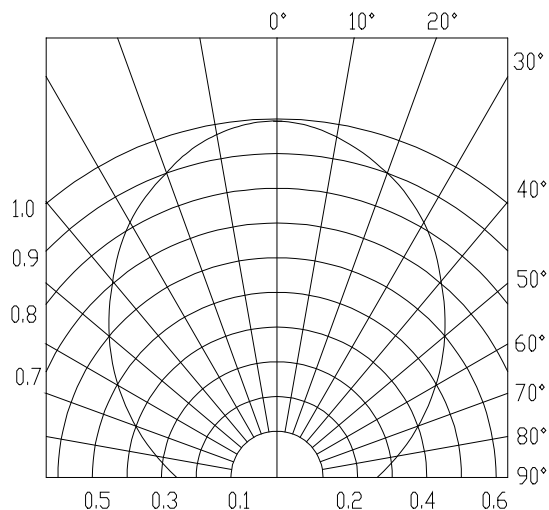
Relative spectral emission

Radiation diagram

Relative luminousintensity



Wavelength(nm)



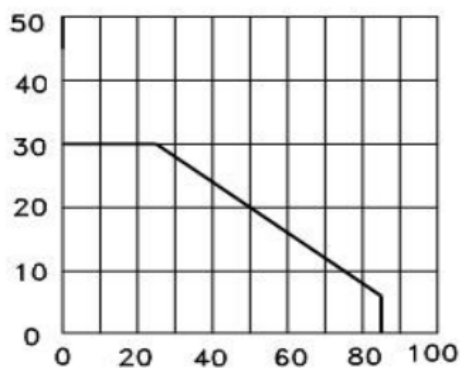
SPATIA DISTRIBUTION

Typical optical characteristics curves (UV)

Ambient Temperature vs. Forward Current

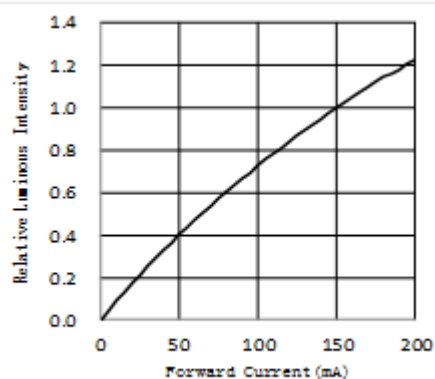
Forward Current VS. Relative Intensity

Forward Current(mA)



Soldering Temperature °C

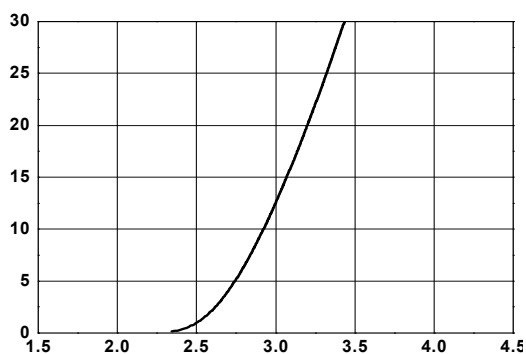
Relative luminous Intensity



Forward Current(mA)

Forward Voltage VS. Forward Current

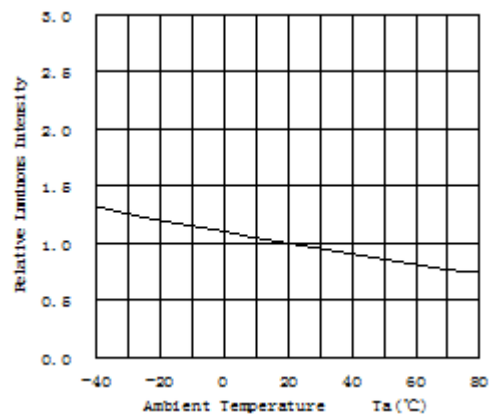
Forward Current(mA)



Forward Voltage(V)

Ambient Temperature VS. Relative Intensity

Relative luminous Intensity

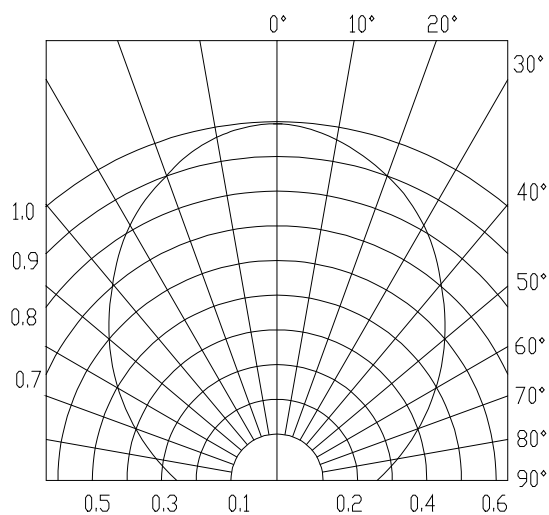


Ambient Temperature ta °C

Relative spectral emission

Radiation diagram

Relative luminousintensity



	Wavelength(nm)		SPATIA DISTRIBUTION
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Reliability Test Items And Conditions

Test Items	Ref	Test Condition	Time	Quantity	Ac/Re
Reflow	JESD22-B106	Temp:260°C max T=10 sec	3 times.	22Pcs.	0/1
Temperature Cycle	JESD22-A104	100 °C ±5 °C 30 min. ↑↓5 min -40 °C ±5 °C 30 min.	100 Cycles	22Pcs.	0/1
High Temperature Storage	JESD22-A103	Temp:100°C±5°C	1000Hrs.	22Pcs.	0/1
Low Temperature Storage	JESD22-A119	Temp:-40°C±5°C	1000Hrs.	22Pcs.	0/1
Life Test	JESD22-A108	Ta=25°C±5°C IF=60mA	1000Hrs.	22Pcs.	0/1
High Temperature High Humidity Life Test	JESD22-A101	85 °C ±5 °C / 85%RH IF=100mA	1000Hrs.	22Pcs.	0/1

Failure Criteria

Test Items	Symbol	Test Condition	Failure Criteria	
			Min.	Max.

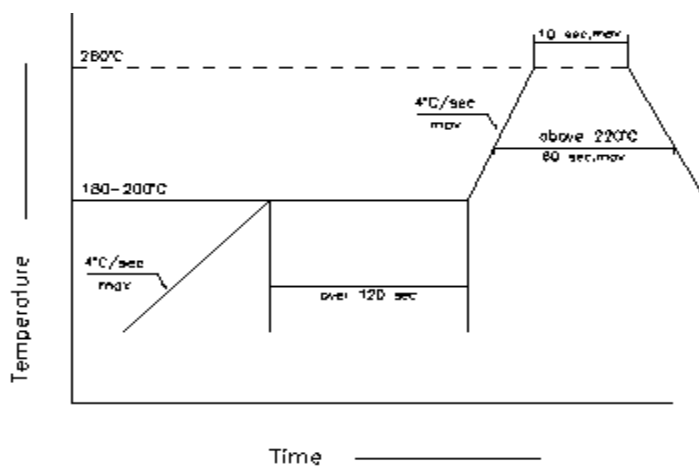
Forward Voltage	VF	IF=60mA	--	U.S.L*)x1.1
Reverse Current	IR	VR = 5V	--	U.S.L*)x2.0
Luminous Flux	lm	IF=60mA	L.S.L*)x0.7	--

U.S.L: Upper Specification Limit

L.S.L: Lower Specification Limit

*The technical information shown in the data sheets is limited to the typical characteristics and circuit examples of the referenced products . It does not constitute the warranting of industrial property nor the granting of any license.

SMT Reflow Soldering Instructions



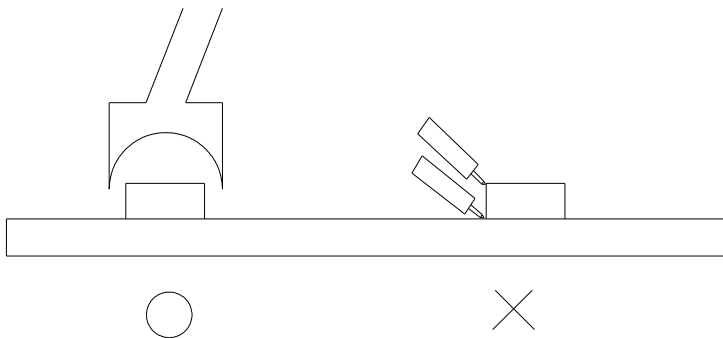
- 1.Reflow soldering should not be done more than two times.
- 2.When soldering , do not put stress on the LEDs during heating

Soldering iron

1. When hand soldering, keep the temperature of iron below less 300°C less than 3 seconds
2. The hand solder should be done only one times

Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed in advance whether the characteristics of LEDs will or will not be damaged by repairing.



Cautions

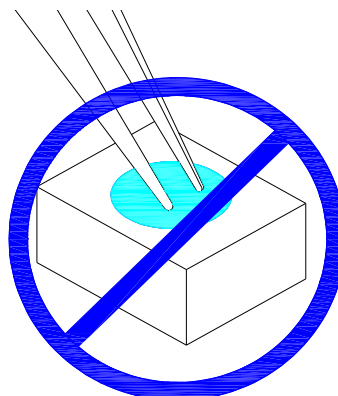
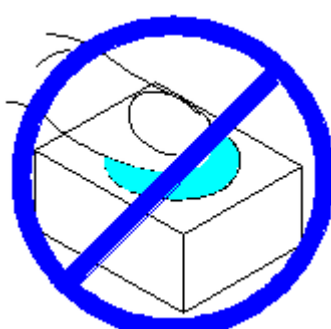
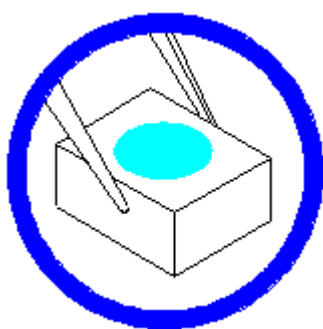
The encapsulated material of the LEDs is silicone. Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when use the picking up nozzle, the pressure on the silicone resin should be proper.

Handling Precautions

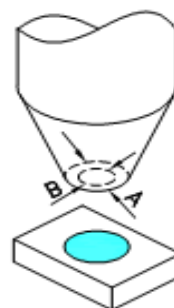
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more prone to damage by external mechanical force . As a result, Special

handling precautions must be observed during assembling using silicone encapsulated LED products, Failure to comply might leads to damage and premature failure of the LED.

1.Handle the component along the side surface by using forceps or appropriate tools; do not directly touch or Handle the silicone lens surface, it may damage the internal circuitry.



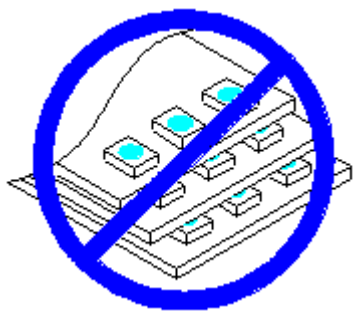
2.The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



3.Do not stack together assembled PCBs containing LEDs. Impact may scratch the silicone lens or damage the internal circuitry

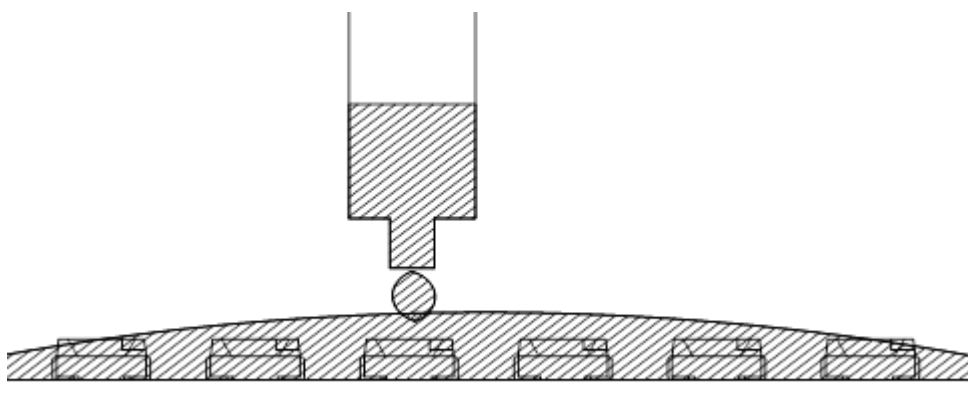
4.Not suitable to operate in acidic environment, PH<7





5.LED operating environment and sulfur element composition cannot be over 100PPM in the LED mating usage material.

6.When we need to use external glue for LED application products, please make sure that the external glue matches the LED packaging glue. Additionally ,as most of LED packaging glue is silica gel, and it has strong Oxygen permeability as well as strong moisture permeability; in order to prevent external material from getting into the inside of LED, which may cause the malfunction of LED, the single content of Bromine element is required to be less than 900PPM,the single content of Chlorine element is required to be less than 900PPM,the total content of Bromine element and Chlorine element in the external glue of the application products is required to be less than 1500PPM



7.Other points for attention, please refer to our LED user manual.

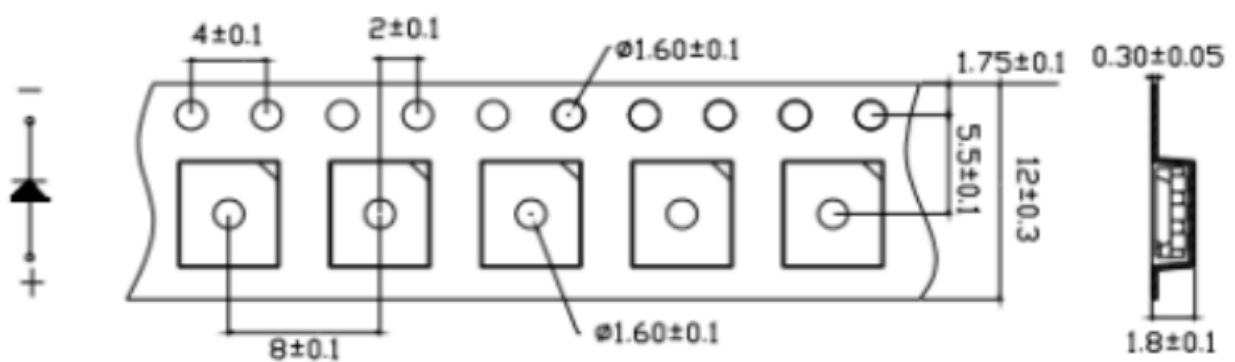
Label 标签

IV: Luminous intensity rank

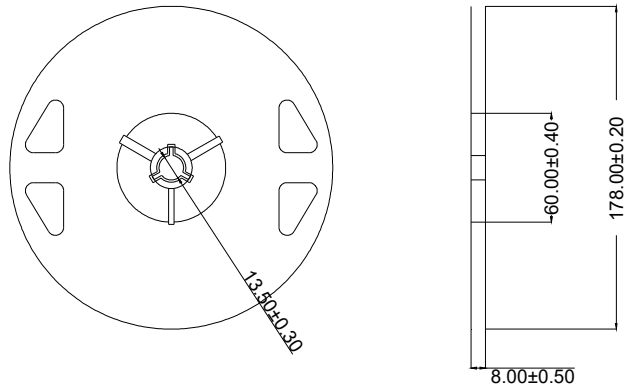
WD: Dominate Wavelength

VF: Forward voltage rank

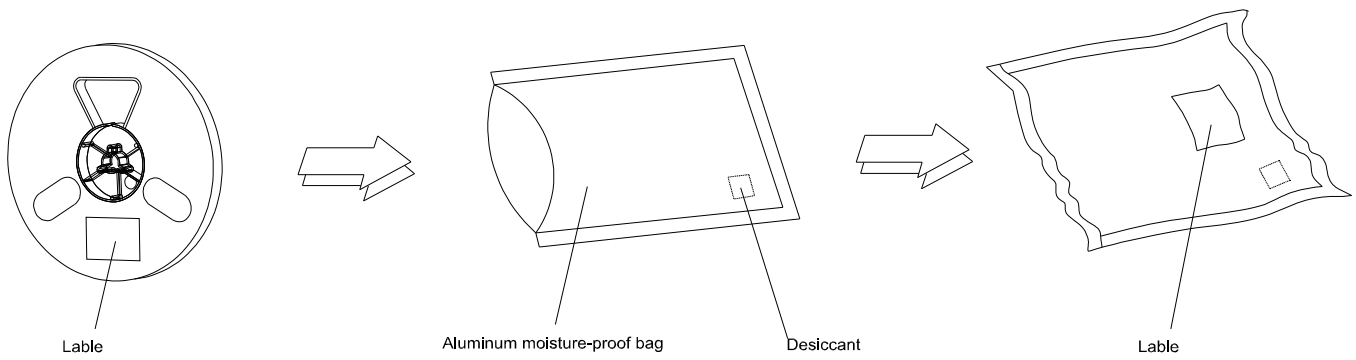
Tape Specifications (Units : mm)



Reel Dimensions



Moisture Resistant Packaging



Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit: mm